



ECOREL[™] FREE 105-16

SAC105 LEAD FREE ALLOY SOLDER PASTE NO CLEAN SMT PRINTING PROCESS ROBUST ASSEMBLY PROCESS

BENEFITS

ECOREL Free 105-16 is a low-silver SAC105 solder paste especially designed to cater high volume electronics with an overall balanced solder paste performance to guarantee a stable assembly process. It's a No Clean solder paste combining the metallurgical properties of SAC 305 alloy with high performance chemistry of the ECORELTM range.

This solder paste has excellent visual solder joint cosmetics with transparent residues, even after multiple reflow cycles. Combining high first pass yield testability in ICT together with very good wetting abilities within different board finishes, including OSP.

	Robust assembly for a stable process
PERFORMANCE	 Very good wetting on all surface finishes, including OSP
PERFORMANCE	 Transparent colorless residue, even after multiple reflow cycles
	 Stable performance up to 31 days when stored at room temperature (30°C max)
COST	 Good first pass yield testability in ICT
	 Cost-saving through reduced silver-content
HSE	No CMR containing substances
	Lead Free & No Halogen

FEATURES

SPECIFICATIONS	ECOREL FREE 105-16
Alloy	SnAg1Cu0.5N
Melting point (°C/°F)	217-227
Metal content (%)	88.0 +/-0,5
Post reflow residues	Approximately 5% by w/w
Halogen content	No Halogen
Powder size	25-45 microns / Type 3
Spiral pump* Viscosity (Pa.s 25°C)	Typical 160

^{*}The equipment used to test spiral pump viscosity is Malcom at a 10 rpm rotation speed.

CHARACTERISTICS

ECOREL FREE 105-16 meets IPC-A-610 voids level (25%) requirement.

ECOREL FREE 105-16 offers excellent characteristics including high speed printing, excellent abandon time, and high pin in paste performance. Its large process window allows for good soldering of medium and large boards.

Fine particle size distribution of type 4 powder enhances the printing quality.

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CHARACTERISTICS	VALUES	
Flux Classification	ROL0	ANSI/J-STD-004
Flux Classification	113	ISO 9454
Solder balling test	Pass	ANSI/J-STD-005
Copper mirror	Pass	ANSI/J-STD-004
Copper corrosion	Pass	ANSI/J-STD-004
Chromate paper	Pass	ANSI/J-STD-004
SIR (IPC)	Pass	ANSI/J-STD-004
SIR (BELLCORE)	Pass	Bellcore
Electromigration (IPC / Bellcore)	Pass	ANSI/J-STD-004 / Bellcore
Oxygen bomb test	Pass	EN 14582

PROCESS RECOMMENDATION

The best process will depend on factors such as operating conditions, equipment, board or component design. Our team is ready to advise you.

SOLDER PASTE PREPARATION

- Put the paste at room temperature for at least 4 hours prior to use.
- Before printing, it is essential to properly mix the solder paste, either manually with a spatula or by doing several preliminary prints on the stencil.
- Automatic solder paste mixing is neither required nor advised.

PRINTING GUIDELINE

Apply the solder paste to the stencil to form a roll of 1 to 2 cm in diameter all along the squeegee or around 100g per 10 cm of squeegee length. This way, the solder paste will roll easily under the squeegees to offer excellent printing quality.

PARAMETER	REMARK
Printing speed	Minimum 20 to maximum 150 mm/s (1 to 6 inch/s)
	Maximum depends on printer capabilities
Minimum pitch	0.3 mm
	Guideline value for a 250 mm squeegee is 7 Kg at 100 mm/s
	Squeegee Printing Speed Pressure
Pressure	ECOREL FREE 105-16
Tressure	
	250 mm 50 mm/sec 3kg
	100mm/sec 5kg
	150mm/sec 7kg
Stencil life in continuous printing process	>12 hours
Abandon time between prints	>4 hours
Steady tackiness	>16 hours

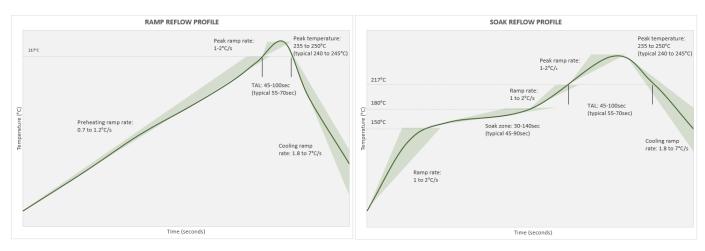
REFLOW GUIDELINE

This paste can be processed under air or nitrogen. Linear preheating ramp rate is recommended, however high-density boards may require a soak zone during preheating to stabilize the temperature over the circuit board before peak reflow.

Although low silver alloys usually show quite similar reflow graph like SAC 305 still it is recommended to choose a slightly higher peak temperature between 240 °C to 255°C.



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REFLOW STEPS	REMARKS	
Preheating ramp rate with linear preheating	0.7 to 1.2°C/s (33 to 34°F/s) (according to the circuit board size and density	
Preheating steps in case of preheating soak zone	 From 20 to 150°C (68 to 302°F): ramp rate 1 to 2°C/s (33 to 36°F/s) Soak zone between 150 to 180°C (302 to 356°F): 30-140s reflow (typical soak 45-90s) From 170°C (380°F) to liquidus 1 to 2°C/s (33 to 36°F/s) 	
Peak ramp rate	1 to 2 °C/s (33 to 36°F/s)	
Peak temperature	235 to 250°C (455 to 582°F) / 240 to 245°C (464 to 473°F) is optimum The paste can stand a temperature higher than 250°C (482°F), but it is not recommended to preserve component integrity	
Time above liquidus	45 to 100s - 55 to 70s typical	
Cooling ramp rate	1.8 to 7°C/s (35 to 45°F/s)	

CLEANING POST SOLDERING

ECOREL FREE 105-16 is a no-clean solder paste, so cleaning is not required to meet IPC standards. The chemistry is specially designed so that any remaining flux residue is chemically inert and will not impact your assembled board or packaging under normal conditions. However, when cleaning is desired or required (e.g. high reliability assembly or to improved conformal coating adhesion), the flux residue can be easily removed with INVENTEC's own formulated flux cleaners.

Inventec has more than 40 years experience in high-tech cleaning for aqueous and solvent based systems.

Our solder materials are aligned with our cleaning solutions, providing you a guaranteed cleaning result with our materials.

PROCESS TYPE	PCBA DEFLUXING SOLUTIONS
Manual	Quicksolv [™] DEF90 EL
Aqueous system (Immersion or spray)	Promoclean [™] DISPER 607
Co-solvent system	Topklean [™] EL 20P or EL 20A + HFE bases solvents
Mono-solvent (Azeotropic)	Promosolv [™] 70ES

Other products available, depending on specific customer requirements. Check also our maintenance cleaning solutions.

PACKAGING, STORAGE & SHELF LIFE

- To ensure the best product performance, the recommended storage temperature range is from 0°C to 10°C.
- For an optimal preservation, store cartridges in a vertical position, tip downwards.
- Shelf-life is 12 month for jars and 9 month for cartridges and proflow cassettes.

AVAILABLE PACKAGING



ECORELTM FREE 105-16 PDS2022-09 ENV



250g & 500g



PROFLOW cassette 750g

HEALTH, SAFETY & ENVIRONMENT

ECOREL FREE 105-16 is NOT a GREENWAY product.

Although fully in line with safety & environmental regulations, this product doesn't match our strict criteria to be labelled as a Greenway product.

More info on our Greenway concept via this link



LOOKING FOR A MORE SUSTAINABLE SOLUTION?

GREENWAY ALTERNATIVE

We currently don't have a Greenway alternative but our target is to develop one
in the near future. In case you want us to prioritize the development of a
Greenway alternative, do not hesitate to contact us.

No issues when used as recommended.

In accordance with the Annex II of Directive 2011/65/UE (RoHS), including its amendments, we certify that this product does not contains quantities above 0.1% of Hg, Pb, Cr VI, PBB, PBDE, DEHP, BBP, DBP, DIBP and above 0.01% of Cd. . INVENTEC PERFORMANCE CHEMICALS also fulfils its direct obligations under the REACH and Conflict Mineral regulations. Please refer always to the Safety Data Sheet (SDS or MSDS) prior to use. Our SDS can be downloaded at www.quickfds.com. We will request to provide your email address, so we can automatically send you a new version of the SDS when a future update would occur.

TECHNICAL SUPPORT & FREE-OF-CHARGE TESTING

Inventec has a worldwide dedicated Technical Support team to help you along the different stages of our cooperation.

Depending on your request, we provide online or onsite support

- to select the right product based on your specific needs
- to assist you in your product qualification process
- to guide you with the initial set up of you process at all your worldwide manufacturing facilities
- to provide fast response on technical issues which could occur at any time during mass production.

When prior cleaning is required, customers are also welcome in our CLEANING CENTERS to see the process in action and to get convinced by our solutions. We cover water- and solvent based processes.

Inventec is unique in the world by developing not only soldering materials but also cleaning and coating solutions. These materials are very closely linked with each other from a process point of view. Talking to our Technical Team, who understands very well these 3 different product groups, will help you greatly to overcome technical challenges within your overall process.

Contact our technical support via contact@inventec.dehon.com or your local sales representative.

ABOUT INVENTEC

Inventec is a global provider of SOLDERING, CLEANING & COATING materials for Electronic, Semiconductor and Industrial applications. For over 40 years we have shown leadership in innovation by putting HEALTH IMPACT, SUSTAINABILITY and RELIABILITY at the core of our product development.



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With ISO 9001 & 14001 production sites in France, Switzerland, USA, Mexico, Malaysia and China we can guarantee a smooth and cost-effective supply chain.

We supply to many industries but the excellent performance of our products in applications which demand high reliability, leads us to focus especially on the AUTOMOTIVE, AEROSPACE, SEMICONDUCTOR, ENERGY and MEDICAL industry.

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SOLDERING • CLEANING • COATING

This data is based on information that the manufacturer believes to be reliable and offered in good faith. In no event will INVENTEC PERFORMANCE CHEMICALS be responsible for special, incidental and consequential damages. The user is responsible to the Administrative Authorities (regulations for the protection of the Environment) for the conformity of his installation.

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